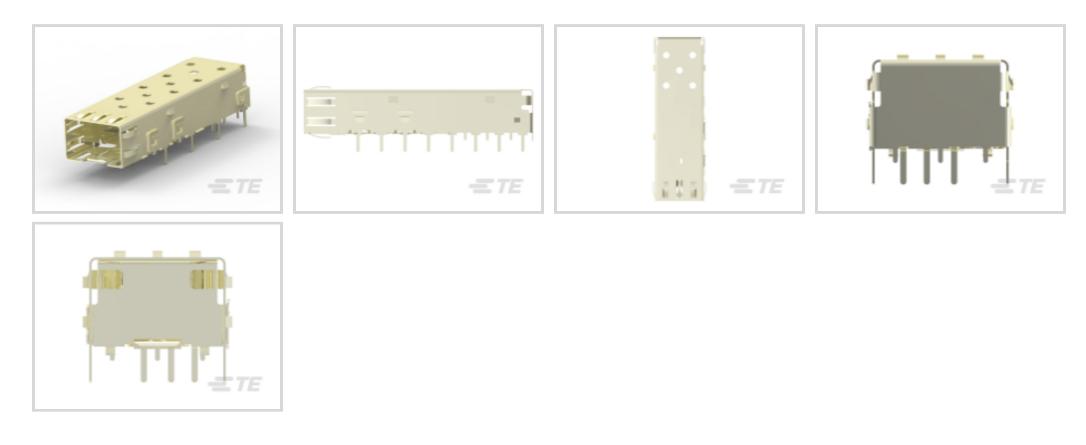
2227303-3 - ACTIVE

TE Internal #: 2227303-3 SFP, SFP+ & zSFP+, Cage, Data Rate (Max) 4 Gb/s, Internal /External EMI Springs, zSFP+ Thermally Enhanced, Not Optional, 1 x 1, Through Hole - Solder

View on TE.com >

Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+



Pluggable I/O Product Type: Cage

Data Rate (Max): 4 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: zSFP+ Thermally Enhanced

Lightpipe Options: Not Optional

Features

Product Type Features



Form Factor	SFP				
Cage Туре	Single				
Pluggable I/O Product Type	Cage				
Lightpipe Options	Not Optional				
Connector System	Cable-to-Board				
Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Port Matrix Configuration	1 x 1				
Number of Ports	1				
Electrical Characteristics					
Data Rate (Max)	4 Gb/s				
Contact Features					
Tail Plating Material	Tin				

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SFP, SFP+ & zSFP+, Cage, Data Rate (Max) 4 Gb/s, Internal/External EMI Springs, zSFP+ Thermally Enhanced, Not Optional, 1 x 1, Through Hole - Solder



Termination Features

Termination Post & Tail Length	1.8 mm[.071 in]					
Termination Method to Printed Circuit Board	Through Hole - Solder					
Mechanical Attachment						
Connector Mounting Type	Board Mount					
Housing Features						
Cage Material	Stainless Steel					
Dimensions						
PCB Thickness (Recommended)	1.5 mm[.059 in]					
Usage Conditions						
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]					
Operation/Application						
Heat Sink Compatible	No					
For Use With Pluggable I/O Products	SFP SMT Connector					
Pluggable I/O Applications	zSFP+ Thermally Enhanced					
Packaging Features						

Packaging Method

Box & Tray, Tray

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Other

EMI Containment Feature Type

Internal/External EMI Springs

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 260°C

C For support call+1 800 522 6752

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SFP, SFP+ & zSFP+, Cage, Data Rate (Max) 4 Gb/s, Internal/External EMI Springs, zSFP+ Thermally Enhanced, Not Optional, 1 x 1, Through Hole - Solder



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # CAT-SF59-C76264 SFP Connectors



TE Part # 1888901-1 SFP+ EMI Plug



TE Part # 1367147-1 SFP COVER, UNPLATED



TE Part # 1367147-3 SFP COVER, UNPL, NO LOGO





Customers Also Bought



2227303-3

SFP, SFP+ & zSFP+, Cage, Data Rate (Max) 4 Gb/s, Internal/External EMI Springs, zSFP+ Thermally Enhanced, Not Optional, 1 x 1, Through Hole - Solder





Documents

CAD Files

Customer View Model

ENG_CVM_CVM_2227303-3_C1.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_2227303-3_C1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2227303-3_C1.3d_igs.zip

English

3D PDF

3D

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Product Specifications

Application Specification

English

Product Environmental Compliance **Product Compliance**

English

Product Compliance

English